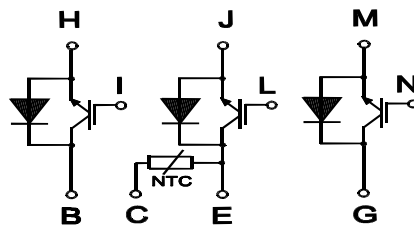
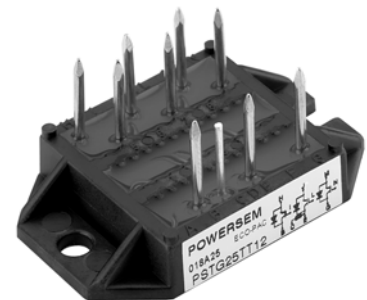


Powerline N-Channel Trench Gate- IGBT Triple Module

PSTG 25HTT12

Preliminary Data Sheet

V_{CES}	= 1200 V
$V_{CE(sat)}$	= 1.9 V
I_{C25}	= 35 A
I_{C75}	= 25 A
I_{CM}	= 75 A
t_{sc}	= 10 μ s



Symbol	Test Conditions	Maximum Ratings	
V_{CES}	$T_{VJ} = 25^{\circ}\text{C to } 150^{\circ}\text{C}$	1200	V
V_{GES}	continuous	± 20	V
I_{C25}	$T_C = 25^{\circ}\text{C};$	35	A
I_{C75}	$T_C = 75^{\circ}\text{C};$	25	A
I_{CM}	$T_C = 75^{\circ}\text{C};$	75	A
P_{tot}	$T_C = 75^{\circ}\text{C}$	45	W
t_{sc}	$V_{CE} = 80 V_{CES}, R_G = 10 \Omega, V_{GE} = \pm 15 \text{ V}$ $T_{VJ} = 125^{\circ}\text{C}, \text{non-repetitive}$	10	μ s
T_{VJ}		-40...+150	$^{\circ}\text{C}$
T_{stg}		-40...+125	$^{\circ}\text{C}$
R_{thJC}	IGBT-per devices	1.65	K/W
R_{thJC}	Diode-per devices	4.0	K/W
V_{ISOL}	$I_{ISOL} \leq 1 \text{ mA}, 50/60 \text{ Hz}, t = 1 \text{ min.}$ 180° sine	3000	V~
M_D	Mounting torque (M4)	1.5-1.8	Nm
		typ.	min.
d_s	Creepage distance on surface	11.2	mm
d_A	Strike distance through air	4.0	mm
Weight	typ.	18	g

Features

- Package with DCB ceramic base plate and soldering pins for PCB mounting
- Isolation voltage over 3000 V~
- Trench Gate
- Enhancement Mode N-Channel Device
- Non Punch through Structure
- High Switching Speed
- Low On-state Saturation Voltage
- High Input Impedance Simplifies Gate Drive
- Latch-Free Operation
- Fully Short Circuit Rated to 10 μ s
- Wide RBSOA

Applications

- High Frequency Inverters
- Motor Control
- Switch Mode Power Supplies
- High Frequency Welding
- UPS Systems
- PWM Drives

Caution: These devices are sensitive to electrostatic discharge. Users should observe proper ESD handling precautions.

Symbol	Test Conditions	Characteristic Value		
		typ.	max.	
I_{CES}	$V_{CE} = V_{CES}, V_{GE} = 0 \text{ V}, T_{VJ} = 25^\circ\text{C}$	0.6		mA
	$T_{VJ} = 125^\circ\text{C}$	3		mA
I_{GES}	$V_{CE} = 0 \text{ V}, V_{GE} = \pm 20 \text{ V}$	1.5		μA
$V_{CE(sat)}$	$I_C = 25 \text{ A}, V_{GE} = 15 \text{ V}, T_{VJ} = 25^\circ\text{C}$	1.9	2.3	V
	$T_{VJ} = 125^\circ\text{C}$	2.1		V
$V_{GE(th)}$	$I_C = 10 \text{ A}, V_{GE} = V_{CE}$	min. 3	5	V
$t_{d(on)}$		170		ns
t_r	Inductive load, $T_{VJ} = 125^\circ\text{C}$	17		ns
$t_{d(off)}$	$V_{CE} = 50\% V_{CES}, I_C = 25 \text{ A}$	340		ns
t_f	$R_G = 5 \Omega, V_{GE} = \pm 15 \text{ V}$	60		ns
E_{on}		2		mJ
E_{off}		3.5		mJ
C_{ies}	$V_{CE} = 75 \text{ V}, V_{GE} = 15 \text{ V}, f = 1 \text{ MHz}$	12000		pF
C_{oes}	$V_{CE} = 75 \text{ V}, V_{GE} = 15 \text{ V}, f = 1 \text{ MHz}$	510		pF
C_{ies}	$V_{CE} = 75 \text{ V}, V_{GE} = 15 \text{ V}, f = 1 \text{ MHz}$	75		pF
R_{thJC}			0.96	K/W
R_{thJS}	with heat transfer paste	tbd		K/W
NTC	25°C	470		k Ω

Package style and outline

Dimensions in mm (1mm = 0.0394")

